



### SURFACE MOUNT FAST SWITCHING DIODE

### **Features**

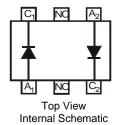
- Ultra-Small Surface Mount Package
- Fast Switching Speed
- For General Purpose Switching Applications
- **High Conductance**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SOT-563 .
- Case Material: Molded Plastic; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.003 grams (approximate)



Top View



### Ordering Information (Note 4)

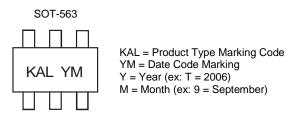
	Part Number	Case	Packaging			
	MMBD4448V-7	SOT-563	3,000/Tape & Reel			
Notes:	tes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.					

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## Marking Information (Note 5)



Date Code Key												
Year	2004	20	05	2006	2007	20	08	2009	2010	20	011	2012
Code	R	93	S	Т	U	١	/	W	Х	,	Y	Z
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Note: 5. Package is non-polarized. Parts may be on reel in orientation illustrated, 180° rotated, or mixed.



# Maximum Ratings (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	57	V
Forward Continuous Current (Note 6)		I <sub>FM</sub>	500	mA
Average Rectified Output Current (Note 6)		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I <sub>FSM</sub>	4.0 1.0	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	150	mW
Thermal Resistance Junction to Ambient (Note 6)	R <sub>θJA</sub>	833	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	80	_	V	I <sub>R</sub> = 2.5μA
		0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage	VF		0.855		$I_F = 10 \text{mA}$
r orward voltage	۷F	—	1.0		I <sub>F</sub> = 100mA
		_	1.25		I <sub>F</sub> = 150mA
			100	nA	V <sub>R</sub> = 70V
Leakage Current (Note 7)	1-		50	μA	V <sub>R</sub> = 75V, T <sub>J</sub> = +150°C
Leakage Current (Note I)	I <sub>R</sub>	_	30	μA	V <sub>R</sub> = 25V, T <sub>J</sub> = +150°C
			25	nA	V <sub>R</sub> = 20V
Total Capacitance	CT	_	3.5	pF	V <sub>R</sub> = 6V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$V_{R} = 6V, I_{F} = 5mA$

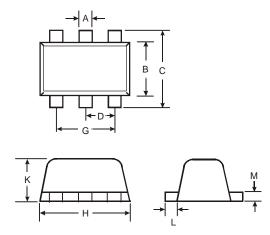
Notes: 6. Device mounted on FR-4 PCB, 1-inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com.

7. Short duration pulse test used to minimize self-heating effect.



# **Package Outline Dimensions**

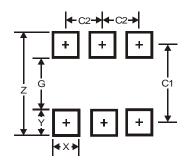
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT-563						
Dim	Min	Max	Тур			
Α	0.15	0.30	0.20			
в	1.10	1.25	1.20			
С	1.55	1.70	1.60			
D	-	-	0.50			
G	0.90	1.10	1.00			
Н	1.50	1.70	1.60			
Κ	0.55	0.60	0.60			
L	0.10	0.30	0.20			
М	0.10	0.18	0.11			
All Dimensions in mm						

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5



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